

## UNISONIC TECHNOLOGIES CO., LTD

### UTT16P10 Preliminary Power MOSFET

# 100V, 16A P-CHANNEL POWER MOSFET

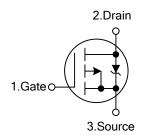
#### ■ DESCRIPTION

The UTC **UTT16P10** is a P-channel power MOSFET using UTC's advanced technology to provide the customers with high switching speed, cost-effectiveness and a minimum on-state resistance. It can also withstand high energy in the avalanche.



- \*  $R_{DS(ON)}$ <0.21 $\Omega$  @  $V_{GS}$ =-10V,  $I_{D}$ =-16A
- \* High Switching Speed

#### ■ SYMBOL



#### ORDERING INFORMATION

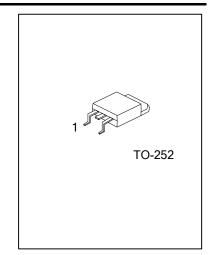
Note: Pin Assignment: G: Gate

Ordering Number		Daaltana	Pin Assignment			Dealine	
Lead Free	Halogen Free	Package	1	2	3	Packing	
UTT16P10L-TN3-R	UTT16P10G-TN3-R	TO-252	G	D	S	Tape Reel	
UTT16P10L-TN3-T	UTT16P10G-TN3-T	TO-252	G	D	S	Tube	

S: Source

D: Drain

UTT16P10L-TN3-R
(1)Packing Type
(1) R: Tape Reel, T: Tube
(2)Package Type
(3)Lead Free
(3) G: Halogen Free, L: Lead Free



#### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>J</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		$V_{DSS}$	-100	V
Gate-Source Voltage		$V_{GSS}$	±20	V
Drain Current	Continuous, T <sub>C</sub> =25°C		-16	Α
	V <sub>GSS</sub> @-10V T <sub>C</sub> =100°C	I <sub>D</sub>	-9.8	Α
	Pulsed (Note 2)	$I_{DM}$	-64	Α
Avalanche Current (Note 2)		I <sub>AR</sub>	-16	Α
Avalanche Energy	Repetitive (Note 3)	E <sub>AS</sub>	345	mJ
	Single Pulsed (Note 2)	E <sub>AR</sub>	15	mJ
Peak Diode Recovery dv/dt		dv/dt	-5.5	V/ns
Power Dissipation (T <sub>C</sub> =25°C)		$P_{D}$	150	W
Junction Temperature		TJ	-55~+150	°C
Storage Temperature		T <sub>STG</sub>	-55~+150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive rating; pulse width limited by max. junction temperature.
- 3.  $V_{DD}$ =-25V, starting  $T_J$ =25°C, L=2.7mH,  $R_G$ =25 $\Omega$ ,  $I_{AS}$ =-16A.

#### ■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Case	$\theta_{JC}$	1.0	°C/W

#### ■ ELECTRICAL CHARACTERISTICS (T<sub>J</sub>=25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	I <sub>D</sub> =-250μA, V <sub>GS</sub> =0V	-100			V	
Breakdown Voltage Temperature Coefficient		$\Delta BV_{DSS}/\Delta T_{J}$	Reference to 25°C, I <sub>D</sub> =-1mA		-0.1		V/°C	
Drain-Source Leakage Current		I <sub>DSS</sub>	V <sub>DS</sub> =-100V, V <sub>GS</sub> =0V,			-25	μΑ	
			V <sub>DS</sub> =-80V, V <sub>GS</sub> =0V, T <sub>J</sub> =150°C			-100	μΑ	
Gate- Source Leakage Current	Forward	I <sub>GSS</sub>	V <sub>GS</sub> =+20V			+100	nΑ	
	Reverse	IGSS	V <sub>GS</sub> =-20V			-100	nA	
ON CHARACTERISTICS	ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$ , $I_D=-250\mu A$			-3.0	V	
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-16A (Note 2)			0.21	Ω	
DYNAMIC PARAMETERS								
Input Capacitance		C <sub>ISS</sub>			1180	1900	pF	
Output Capacitance		Coss	$V_{DS}$ =-25V, $V_{GS}$ =0V, f=1.0MHz		250		pF	
Reverse Transfer Capacitance		C <sub>RSS</sub>			75		pF	
SWITCHING PARAMETERS								
Total Gate Charge		$Q_{G}$			37	60	nC	
Gate to Source Charge		$Q_GS$	V <sub>DS</sub> =-80V, V <sub>GS</sub> =-10V, I <sub>D</sub> =-16A,		5		nC	
Gate to Drain ("Miller") Charge		$Q_{GD}$			15		nC	
Turn-ON Delay Time		t <sub>D(ON)</sub>			11		ns	
Rise Time		t <sub>R</sub>	$V_{DD}$ =-50V, $I_{D}$ =-16A, $R_{G}$ =9.1 $\Omega$ ,		25		ns	
Turn-OFF Delay Time		t <sub>D(OFF)</sub>	$R_D = 2.4\Omega$		56		ns	
Fall-Time		t <sub>F</sub>			36		ns	
SOURCE- DRAIN DIODE RATIN	GS AND CH	ARACTERIS	TICS			•		
Maximum Body-Diode Continuous Current		Is				-16	Α	
Maximum Body-Diode Pulsed Cu	rrent	I <sub>SM</sub>	(Note 1)			-64	Α	
Drain-Source Diode Forward Volt	age	$V_{SD}$	I <sub>S</sub> =-16A, V <sub>GS</sub> =0V (Note 2)			-1.3	V	

Notes: 1. Repetitive rating; pulse width limited by max. junction temperature.

2. Pulse width≤300µs; duty cycle≤2%.



#### ■ TEST CIRCUITS AND WAVEFORMS

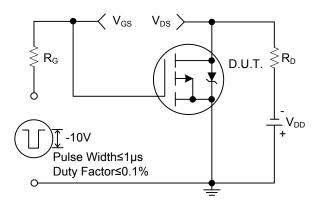


Fig. 1 Switching Time Test Circuit

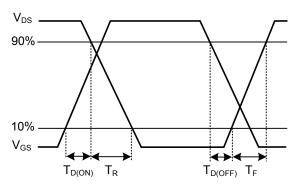


Fig. 2 Switching Time Waveforms

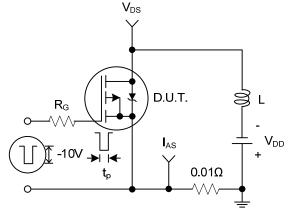


Fig. 3 Unclampled Inductive Test Circuit

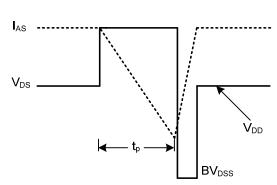


Fig. 4 Unclampled Inductive Waveforms

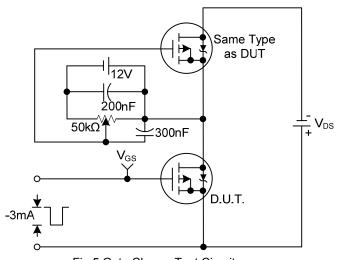


Fig.5 Gate Charge Test Circuit

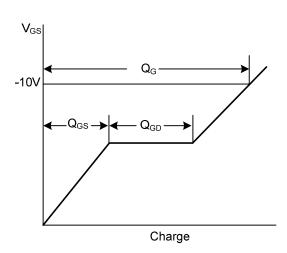


Fig. 6 Gate Charge Waveform

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